

## SB5T120

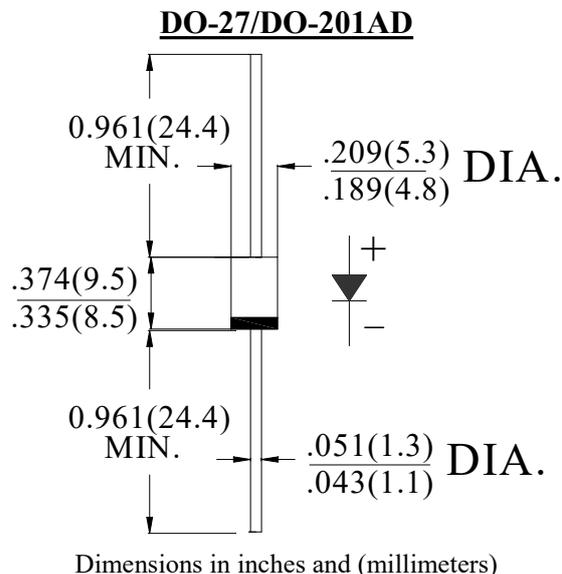
### 5.0AMPS. SCHOTTKY BARRIER RECTIFIERS

#### FEATURE

- . For surface mounted application
- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge current capability
- . High temperature soldering guaranteed:  
260°C/10 seconds at terminals.

#### MECHANICAL DATA

- . Terminal: Solder plated
- . Case: Molded with UL-94 Class V-0 recognized  
Flame Retardant Epoxy (free halogen)
- . Polarity: color band denotes cathode
- . Mounting position: any



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	SYMBOL	SB5T120	units
	Marking	SB5T120	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	120	V
Maximum RMS Voltage	$V_{RMS}$	84	V
Maximum DC blocking Voltage	$V_{DC}$	120	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	5.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	$I_{FSM}$	100	A
Maximum Forward Voltage	$V_F$	@ $I_F=5A$	0.68
		@ $I_F=1A$	0.52
Maximum DC Reverse Current at rated DC blocking voltage	$I_R$	@ $T_J=25^\circ C$	0.2
		@ $T_J=100^\circ C$	10.0
Typical Junction Capacitance (Note1)	$C_J$	650	pF
Typical Thermal Resistance (Note2)	$R_{(JC)}$	14	°C/W
Storage Temperature	$T_{STG}$	-55 to +150	°C
Operating Junction Temperature	$T_J$	-55 to +150	°C

#### Note:

1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
2. Thermal Resistance from Junction to Ambient and Lead at 0.375"(9.5mm)lead length, vertical P.C.Board Mounted.

**RATING AND CHARACTERISTIC CURVES**

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

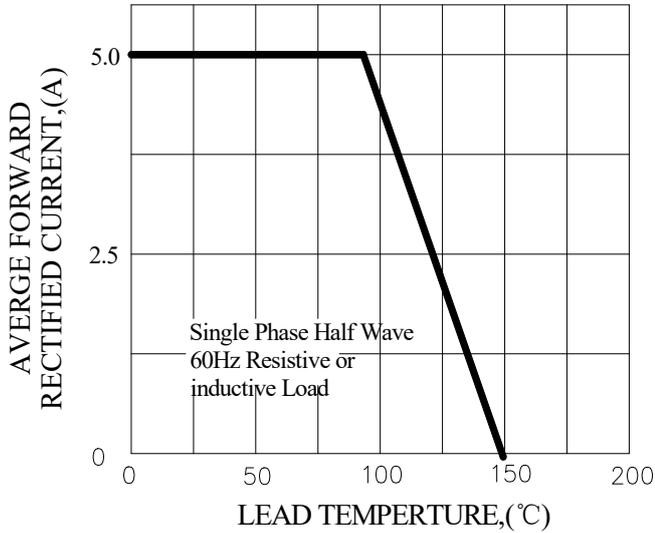


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

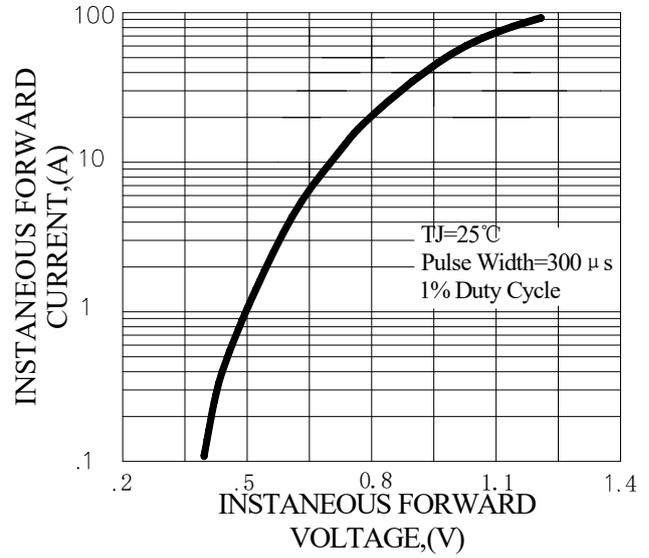


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

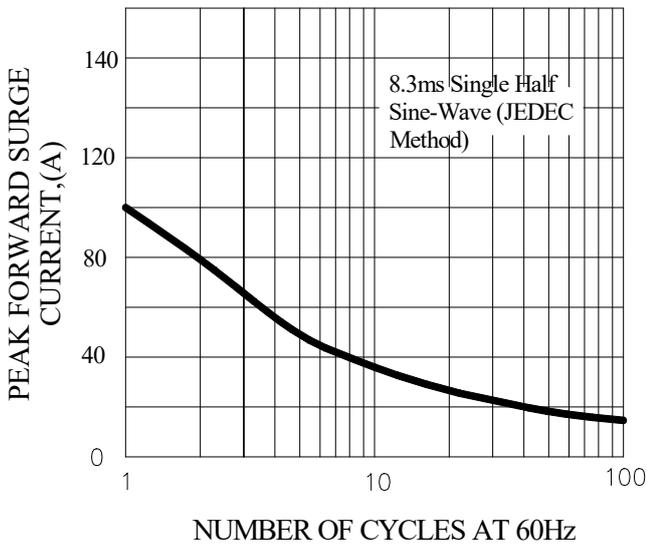
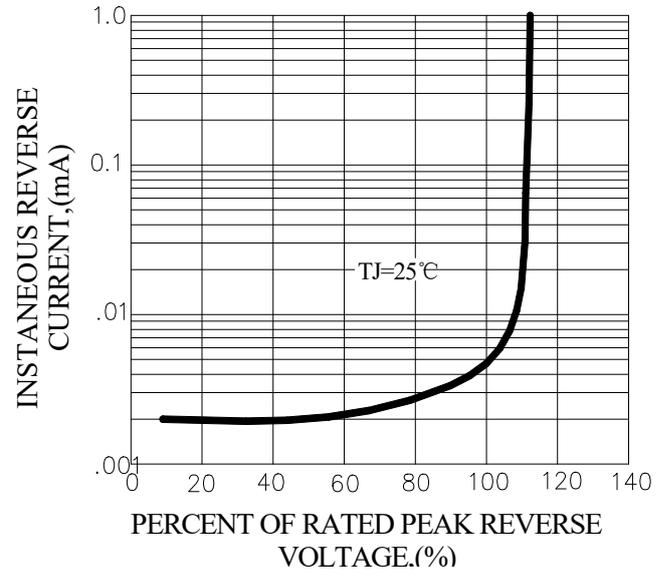
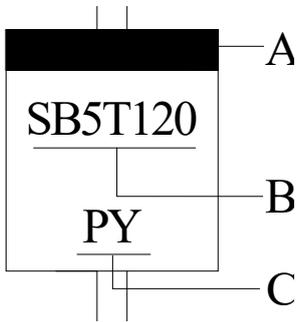


FIG.4-TYPICAL REVERSE CHARACTERISTICS



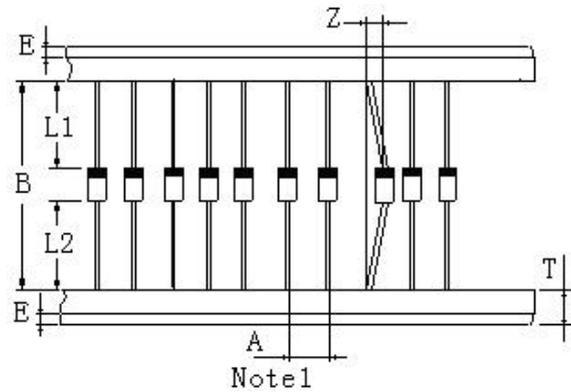
## Marking and packaging illustration

### 1、Marking



SYMBOL	Explanation
A	Color Band Denotes Cathode
B	Product Name
C	Trademark

### 2、Packaging



ITEM	SYMBOL	SPECIFICATIONS	
		(mm)	(inch)
Component alignment	Z	1.2max	0.048max
Tape width	T	6.0±0.4	0.236±0.016
Exposed adhesive	E	0.8max	0.032max
Body eccentricity	L1-L2	1.0max	0.040max
Component	A	10.0±0.5	0.4±0.02
Inner tap	B	52.0~53.5	2.05~2.11
NOTE: Each component lead shall be sandwiched between tapes for a minimum of 2.5mm (0.1inch)			